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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Programmable transient voltage suppressor for SLIC protection

Datasheet - production data

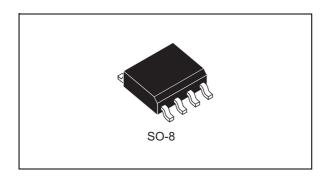
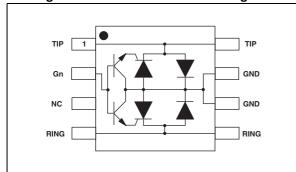


Figure 1. LCP1531 functional diagram



Features

- Dual programmable transient suppressor
- Wide negative firing voltage range: $V_{Gn} = -175 \text{ V max}$.
- Low dynamic switching voltages: V_{FP} and V_{DGI}
- Low gate triggering current: I_{GT} = 5 mA max
- Peak pulse current: $I_{PP} = 37.5 \text{ A} (5/310 \text{ }\mu\text{s})$
- Holding current: I_H = 150 mA min.
- · Low space consuming package

Benefits

- A TrisilTM is not subject to ageing and provides a fail-safe mode in short circuit for better protection.
- Trisils are used to help equipment to meet various standards such as YDT695, GR-1089 and ITU-T K20/21.
- Trisils are UL94 V0 resin approved and are UL497B approved [file: E136224]).

Description

These devices are ideally suited to meet the protection requirement of VoIP SLICs located in next generation residential gateways. They can be used for protecting any ringing SLIC since they meet the protection standard requirements.

Positive overvoltages are clamped by 2 diodes. Negative surges are suppressed by 2 thyristors, their breakdown voltage being referenced to ${}^{-}V_{BAT}$ through the gate.

These components present a very low gate triggering current (I_{GT}) to reduce the current consumption on printed circuit board during the firing phase.

TM: Trisil is a trademark of STMicroelectronics

Characteristics LCP1531

1 Characteristics

Table 1. Standards compliance

Table 1. Gardand Gomphanee					
Standard	Peak surge voltage (V)	Voltage waveform	Required peak current (A)	Current waveform	Minimum serial resistor to meet standard (Ω)
OD 1000 O First Issuel	2500	2/10 μs	500	2/10 μs	20
GR-1089 Core First level	1000	10/1000 μs	100	10/1000 μs	30
GR-1089 Core Second level	5000	2/10 μs	500	2/10 μs	40
GR-1089 Core Intra-building	1500	2/10 μs	100	2/10 μs	0
ITU-T-K20/K21	6000 1500	10/700 μs	150 37.5	5/310 μs	120 0
ITU-T-K20 (IEC 61000-4-2)	8000 15000	1/60 ns		ct discharge discharge	0
IEC 61000-4-5	4000 4000	10/700 μs 1.2/50 μs	100 100	5/310 μs 8/20 μs	67 22
TIA-968-A,	1500	10/160 μs	200	10/160 μs	26
lightning surge type A	800	10/560 μs	100	10/560 μs	17
TIA-968-A, lightning surge type B	1500	9/720 μs	37.5	5/320 μs	0

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient	120	°C/W

LCP1531 Characteristics

Table 3. Absolute ratings (T_{amb} = 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
		10/1000 μs	25	
		8/20 μs	65	
		10/560 μs	32	
I _{PP}	Peak pulse current	5/310 μs	37.5	Α
		10/160 μs	45	
		1/20 μs	60	
		2/10 μs	100	
	Non repetitive curse peak on state current	t = 20 ms	16	
I _{TSM}	Non-repetitive surge peak on-state current (50 Hz sinusoidal)	t = 200 ms	9	Α
		t = 1 s	6	
I _{GSM}	Maximum gate current (50 Hz sinusoidal)	2	Α	
V_{Gn}	Negative battery voltage range	-175	V	
T _{stg}	Storage temperature range	-55 to +150	٥°	
T _j	Operating junction temperature range	-40 to +150	C	
T_L	Maximum lead temperature for soldering du	uring 10 s.	260	ô

Figure 2. Electrical characteristics (definitions)

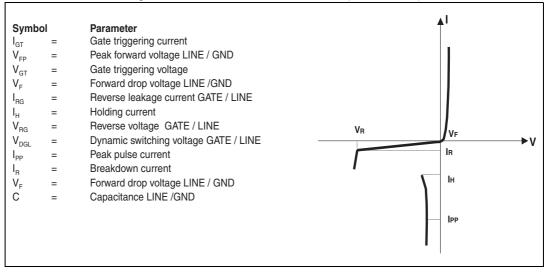
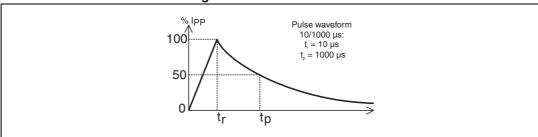


Figure 3. Pulse waveform



Characteristics LCP1531

Table 4. Parameters related to the diode LINE / GND (T_{amb} = 25 °C)

Symbol		Test conditions		Max.	Unit
V _F	I _F = 5 A		t = 500 μs	3	V
V _{FP}	10/700 μs	V _{PP} = 1.5 kV	R _S = 15 Ω	5	V

Table 5. Parameters related to the protection thyristors (T_{amb} = 25 °C)

Symbol	Test conditions	Min.	Max.	Unit
I _{GT}	V _{LINE} = -48 V	0.1	5	mA
I _H	V _{Gn} = -48 V	150		mA
I _{RG}	V _{RG} = -75 V		5	μΑ
V	$V_{Gn} = -48 V^{(1)}$			
V _{DGL}	10/700 μs $V_{PP} = 1.5 \text{ kV}$ $R_{S} = 15 \Omega$ $I_{PP} = 27.5 \text{ A}$		7	V

^{1.} The oscillations with a time duration lower than 50 ns are not taken into account.

Table 6. Parameters related to diode and protection thyristors (T_{amb} = 25 °C,)

Symbol	Test conditions		Тур.	Max.	Unit
I _R	$V_{Gn/LINE} = -1 V V_{RM} = -75 V$	T _j = 25 °C		5	μΑ
С	V _{LINE} = -50 V, V _{RMS} = 1 V, F = 1 MHz V _{LINE} = -2 V, V _{RMS} = 1 V, F = 1 MHz		15 35		pF

Table 7. Recommended gate capacitance

Symbol	Component		Тур.	Max.	Unit
C _G	Gate decoupling capacitance	100	220		nF



LCP1531 Technical information

2 Technical information

Figure 4. LCP1531 concept behavior

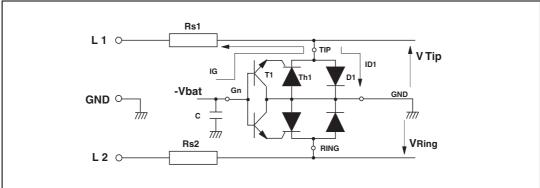


Figure 4. shows the classical protection circuit using the LCP1531 crowbar concept. This topology has been developed to protect the new high voltage SLICs. It allows to program the negative firing threshold while the positive clamping value is fixed at GND.

When a negative surge occurs on one wire (L1 for example) a current IG flows through the base of the transistor T1 and then injects a current in the gate of the thyristor Th1. Th1 fires and all the surge current flows through the ground. After the surge when the current flowing through Th1 becomes less negative than the holding current I_H, then Th1 switches off.

When a positive surge occurs on one wire (L1 for example) the diode D1 conducts and the surge current flows through the ground.

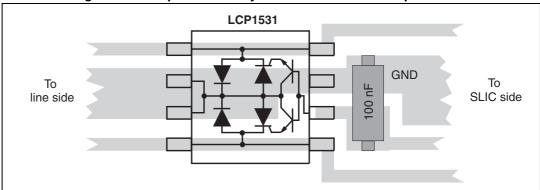


Figure 5. Example of PCB layout based on LCP1531 protection

Figure 5. shows the classical PCB layout used to optimize line protection.

The capacitor C is used to speed up the crowbar structure firing during the fast surge edges.

This allows minimization of the dynamic breakover voltage at the SLIC Tip and Ring inputs during fast strikes. Note that this capacitor is generally present around the SLIC - V_{bat} pin.

So to be efficient it has to be as close as possible from the LCP1531 Gate pin and from the reference ground track (or plan) (see *Figure 5*.). The optimized value for C is 100 nF.

Technical information LCP1531

The series resistors Rs1 and Rs2 designed in *Figure 4.* represent the fuse resistors or the PTC which are mandatory to withstand the power contact or the power induction tests imposed by the various country standards. Taking into account this fact the actual lightning surge current flowing through the LCP1531 is equal to:

$$I_{surge} = V_{surge} / (R_g + R_s)$$

With:

V _{surge} = peak surge voltage imposed by the standard.

 R_q = series resistor of the surge generator

 R_s = series resistor of the line card (e.g. PTC)

The LCP1531 is particularly optimized for the new telecom applications such as the fiber in the loop, the WLL, the remote central office. In this case, the operating voltages are smaller than in the classical system. This makes the high voltage SLICs particularly suitable.

The schematics of *Figure 6*. gives the most frequent topology used for these applications.

-Vbat Rs (*) TIP Gn TIF GND GND SLIC GND Line RING Rs (*) RING LCP1531 Th) Line card Rs (*) = PTC or fuse resistor

Figure 6. Protection of high voltage SLIC

Figure 7. Surge peak current versus overload duration

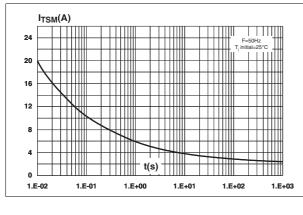
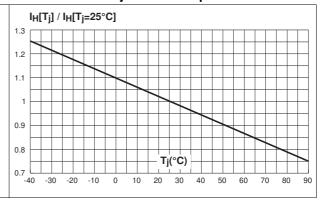


Figure 8. Relative variation of holding current versus junction temperature



LCP1531 Package information

3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

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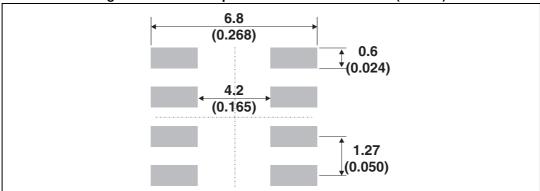
Figure 9. SO-8 dimension definitions

Package information LCP1531

Table 8. SO-8 dimension values

	Dimensions						
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α			1.75			0.069	
A1	0.1		0.25	0.004		0.010	
A2	1.25			0.049			
b	0.28		0.48	0.011		0.019	
С	0.17		0.23	0.007		0.009	
D	4.80	4.90	5.00	0.189	0.193	0.197	
E	5.80	6.00	6.20	0.228	0.236	0.244	
E1	3.80	3.90	4.00	0.150	0.154	0.157	
е		1.27			0.050		
h	0.25		0.50	0.010		0.020	
L	0.40		1.27	0.016		0.050	
L1		1.04			0.041		
k°	0		8	0		8	
ccc			0.10			0.004	

Figure 10. SO-8 footprint measurements in mm (inches)



4 Ordering information

Table 9. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
LCP1531RL	CP153	SO-8	0.08 g	2500	Tape and reel

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
23-Mar-2007	1	First issue.
10-Apr-2008	2	Reformatted for current standards. Changed gate capacitance from 220 nF to 100 nF.
10-Aug-2011	3	Updated standards in <i>Table 1</i> .
23-Feb-2012	4	Standardized nomenclature for Gn.
27-Aug-2013	5	Updated Table 1, Table 3, Figure 9 and Figure 10.



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